



14 Gbps, FAST RISE TIME D-TYPE FLIP-FLOP w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

Typical Applications

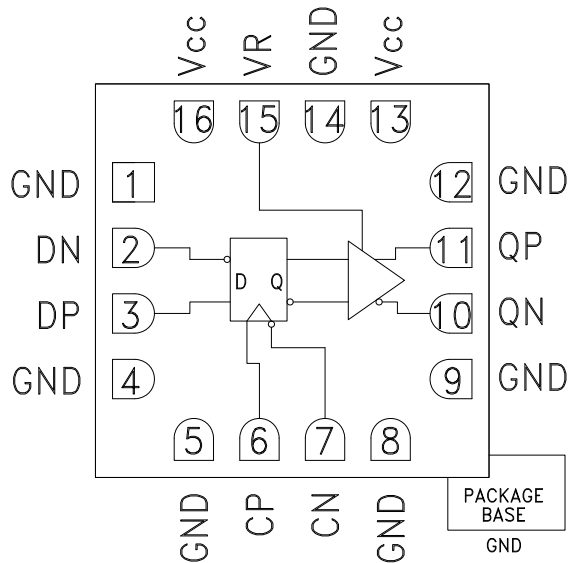
The HMC747LC3C is ideal for:

- RF ATE Applications
- Broadband Test & Measurement
- Serial Data Transmission up to 14 Gbps
- Digital Logic Systems up to 14 GHz

Features

- Supports High Data Rates: up to 14 Gbps
- Differential & Single-Ended Operation
- Fast Rise and Fall Times: 22 / 20 ps
- Low Power Consumption: 264 mW typ.
- Programmable Differential Output Voltage Swing: 700 - 1300 mV
- Propagation Delay: 105 ps
- Single Supply: +3.3 V
- 16 Lead Ceramic 3x3 mm SMT Package: 9 mm²

Functional Diagram



General Description

The HMC747LC3C is a D-Type Flip-Flop designed to support data transmission rates of up to 14 Gbps, and clock frequencies as high as 14 GHz. During normal operation, data is transferred to the outputs on the positive edge of the clock. Reversing the clock inputs allows for negative-edge triggered applications.

All differential inputs to the HMC747LC3C are CML and terminated on-chip with 50 ohms to the positive supply, V_{cc}, and may be AC or DC coupled. The differential CML outputs are source terminated to 50 ohms and may also be AC or DC coupled. Outputs can be connected directly to a 50 ohm V_{cc}-terminated system, while DC blocking capacitors may be used if the terminating system is 50 ohms to ground. The HMC747LC3C also features an output level control pin, VR, which allows for loss compensation or signal-level optimization. The HMC747LC3C operates from a single 3.3 V supply and is available in ROHS-compliant 3x3 mm SMT package.

Electrical Specifications, T_A = +25 °C, V_{cc} = 3.3 V, VR = 3.3 V

| Parameter | Conditions | Min. | Typ. | Max | Units |
|--------------------------|----------------------------|-----------------------|------|-----------------------|-------|
| Power Supply Voltage | | 3.0 | 3.3 | 3.6 | V |
| Power Supply Current | | | 80 | | mA |
| Maximum Data Rate | | | 14 | | Gbps |
| Maximum Clock Rate | | | 14 | | GHz |
| Input Voltage Range | | V _{cc} - 1.5 | | V _{cc} + 0.5 | V |
| Input Differential Range | | 0.1 | | 2 | Vp-p |
| Input Return Loss | Frequency <14 GHz | | 10 | | dB |
| Output Amplitude | Single-Ended, peak-to-peak | | 550 | | mVp-p |
| | Differential, peak-to-peak | | 1100 | | mVp-p |
| Output High Voltage | | | 3.29 | | V |

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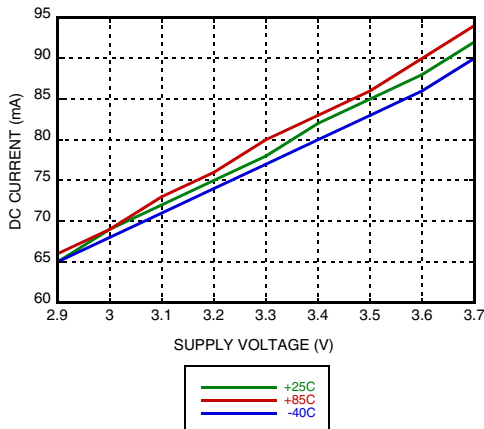
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Electrical Specifications (continued)

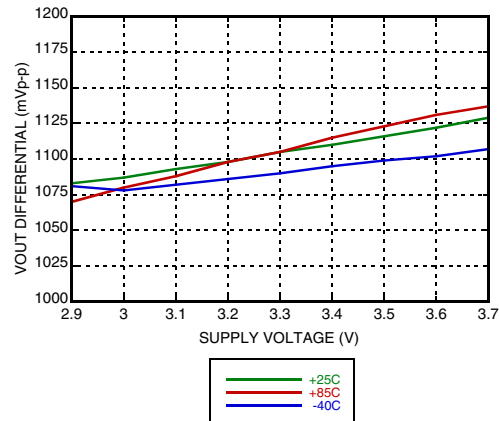
| Parameter | Conditions | Min. | Typ. | Max | Units |
|-------------------------------------|---|------|---------|-----|---------|
| Output Low Voltage | | | 2.74 | | V |
| Output Rise / Fall Time | Differential, 20% - 80% | | 22 / 20 | | ps |
| Output Return Loss | Frequency <13 GHz | | 10 | | dB |
| Random Jitter Jr | rms | | | 0.2 | ps rms |
| Deterministic Jitter, Jd | peak-to-peak, 2 ¹⁵ -1 PRBS input [1] | | 2 | | ps, p-p |
| Propagation Delay Clock to Data, td | | | 105 | | ps |
| Clock Phase Margin | 13 GHz | | 320 | | deg |
| Set Up & Hold Time, t _{SH} | | | 6 | | ps |
| VR Pin Current | VR = 3.3 V | | 2 | | mA |
| VR Pin Current | VR = 3.7 V | | | 3.5 | mA |

[1] Deterministic jitter calculated by simultaneously measuring the jitter of a 300 mV, 13 GHz, 2¹⁵-1 PRBS input, and a single-ended output

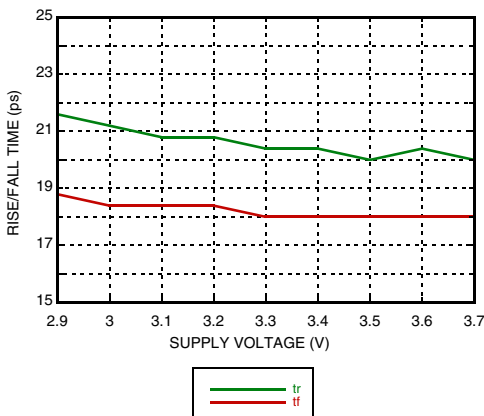
DC Current vs. Supply Voltage [1][2]



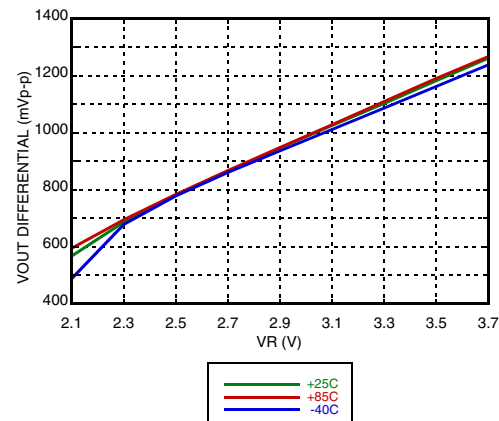
Output Differential Voltage vs. Supply Voltage [1][2]



Rise / Fall Time vs. Supply Voltage [1][2]



Output Differential Voltage vs. VR [1][2]



[1] VR = 3.3 V

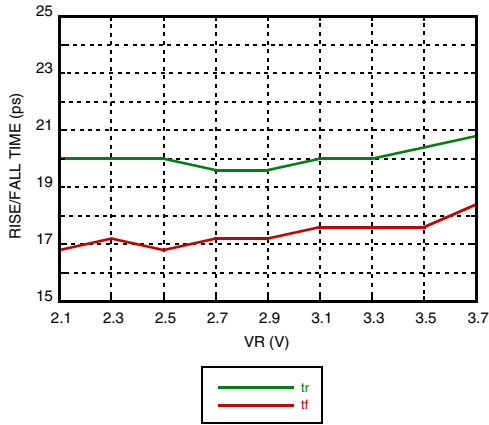
[2] Frequency = 13 GHz

[3] Vcc = 3.3 V

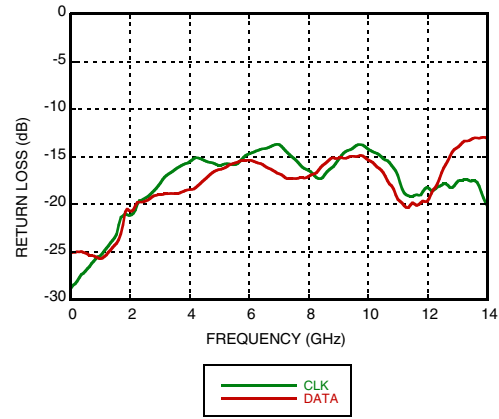


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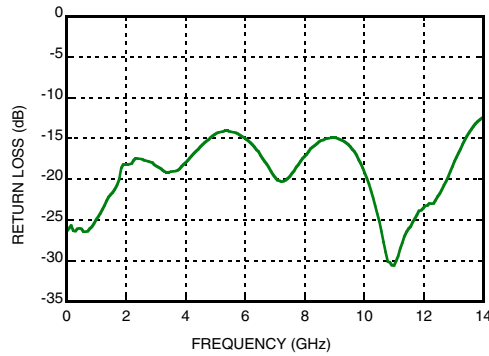
Rise / Fall Time vs. VR [1][2]



Input Return Loss vs. Frequency



Output Return Loss vs. Frequency



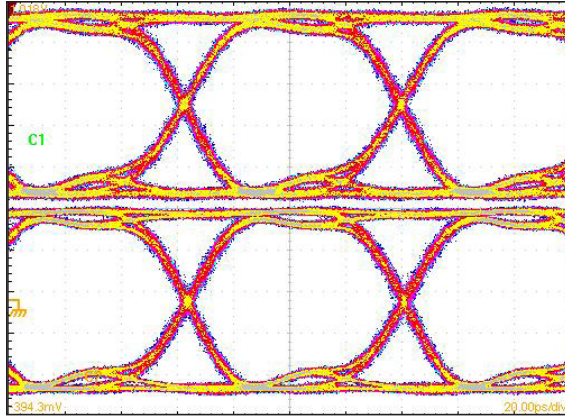
[1] Vcc = 3.3 V

[2] Frequency = 13 GHz

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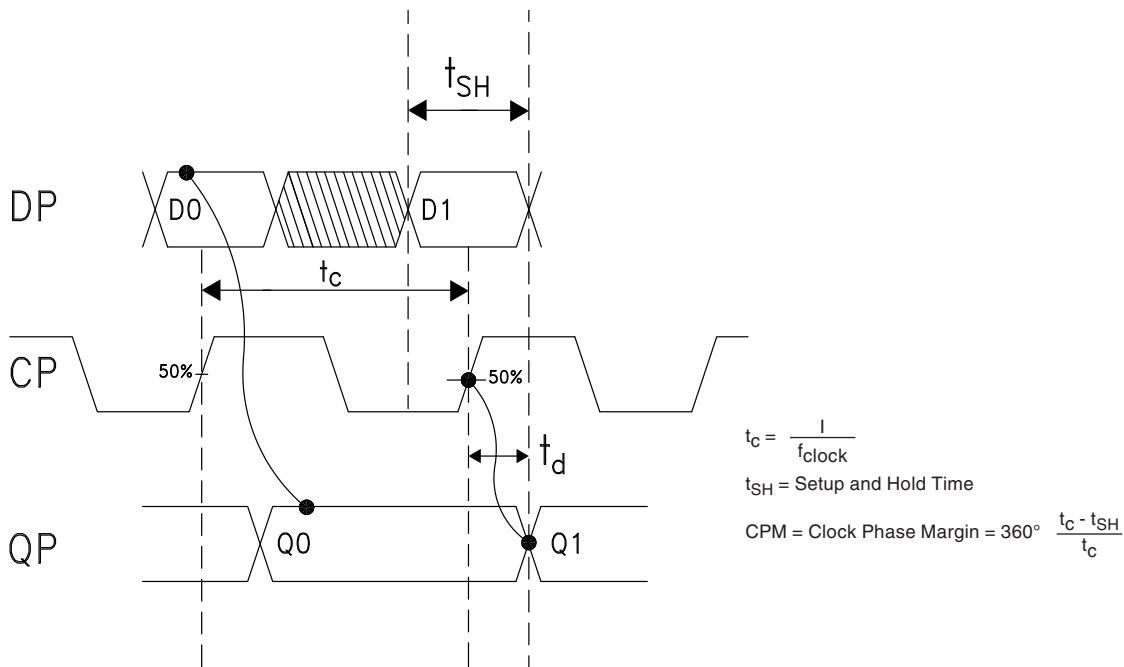


Eye Diagram



[1] Test Conditions:
 Pattern generated with an Agilent N4903A Serial BERT.
 Eye Diagram presented on a Tektronix CSA 8000.
 Device input = 13 Gbps PN code.
 Both output channels shown.
 Device is AC coupled to scope.

Timing Diagram



Truth Table

| Input | | Outputs |
|-------|--------|---------|
| D | C | Q |
| L | L -> H | L |
| H | L -> H | H |

Notes:
 D = DP - DN
 C = CP - CN
 Q = QP - QN
 H - Positive voltage level
 L - Negative voltage level

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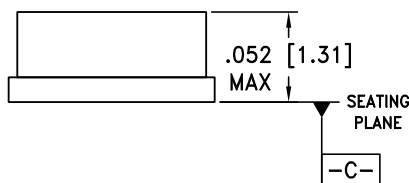
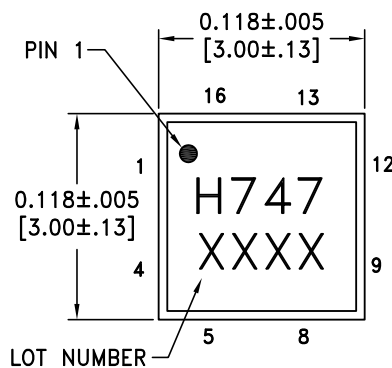
Absolute Maximum Ratings

| | |
|--|----------------------------|
| Power Supply Voltage (Vcc) | Vcc -0.5 V to 3.75 V |
| Input Signals | Vcc - 2.0 V to Vcc + 0.5 V |
| Output Signals | Vcc - 1.5 V to Vcc + 0.5 V |
| Continuous Pdiss (T = 85 °C) (derate 17 mW/°C above 85 °C) | 0.68 W |
| Thermal Resistance (R _{th j-p}) worst case junction to package paddle | 59 °C/W |
| Maximum Junction Temperature | 125 °C |
| Storage Temperature | -65 °C to +150 °C |
| Operating Temperature | -40 °C to +85 °C |
| ESD Sensitivity (HBM) | Class 1C |

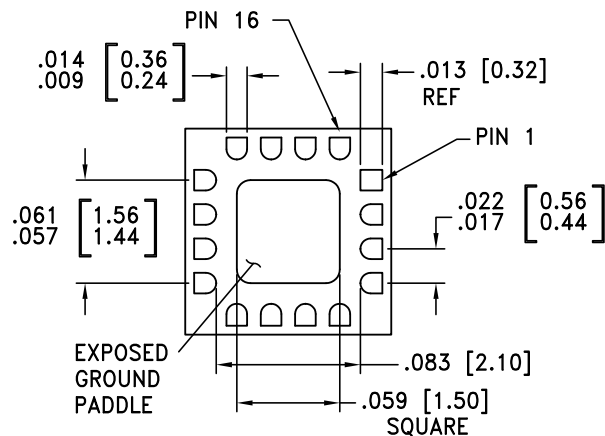


ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



BOTTOM VIEW



NOTES:

- PACKAGE BODY MATERIAL: ALUMINA
- LEAD AND GROUND PADDLE PLATING:
30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
- DIMENSIONS ARE IN INCHES [MILLIMETERS].
- LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- PACKAGE WARP SHALL NOT EXCEED 0.05 mm DATUM -C-
- ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.
- PADDLE MUST BE SOLDERED TO GND.

Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ^[2] |
|-------------|-----------------------|------------------|---------------------|--------------------------------|
| HMC747LC3C | Alumina, White | Gold over Nickel | MSL3 ^[1] | H747 XXXX |


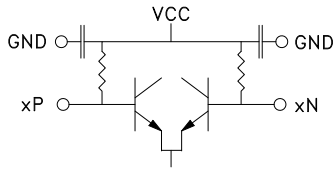
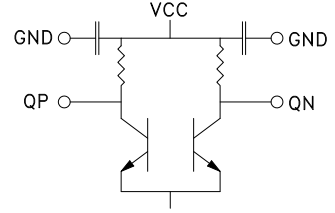

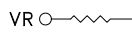
[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX



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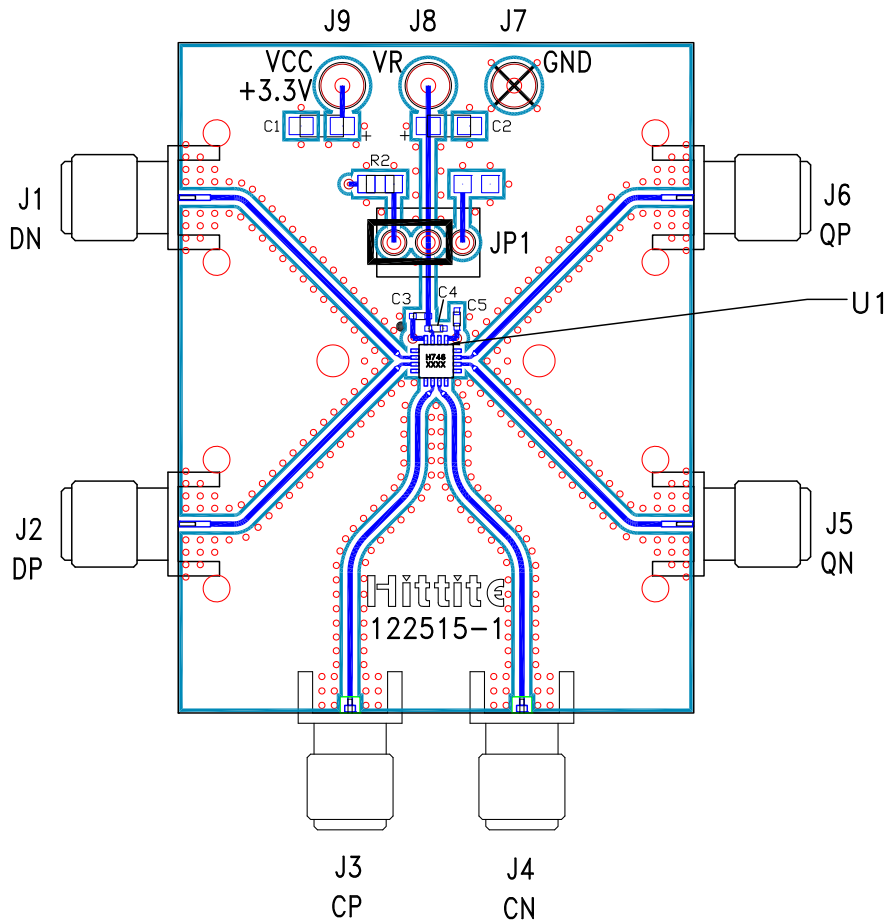
Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|---------------------|------------------|---|---|
| 1, 4, 5, 8, 9, 12 | GND | Signal Grounds |  |
| 2, 3 6, 7 | DN, DP CP, CN | Differential Data Inputs: Current Mode Logic (CML) referenced to positive supply. |  |
| 10, 11 | QN, QP | Differential Data Outputs: Current Mode Logic (CML) referenced to positive supply.s |  |
| 13, 16 | Vcc | Positive Supply | |
| 14, Package Base | GND | Supply Ground |  |
| 15 | VR | Output level control. Output level may be adjusted by applying a voltage to VR per "Output Differential vs. VR" plot. |  |



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Evaluation PCB



**List of Materials for
Evaluation PCB EVAL01-HMC747LC3C [1]**

| Item | Description |
|---------|--|
| J1 - J6 | PCB Mount SMA RF Connectors |
| J7 - J9 | DC Pin |
| JP1 | Shorting Jumper |
| C1, C2 | 4.7 μ F Capacitor, Tantalum |
| C3 - C5 | 100 pF Capacitor, 0402 Pkg. |
| R2 | 10 Ohm Resistor, 0603 Pkg. |
| U1 | HMC747LC3C High Speed Logic, D-Type Flip-Flop |
| PCB [2] | 122515 Evaluation Board |

[1] Reference this number when ordering complete evaluation PCB

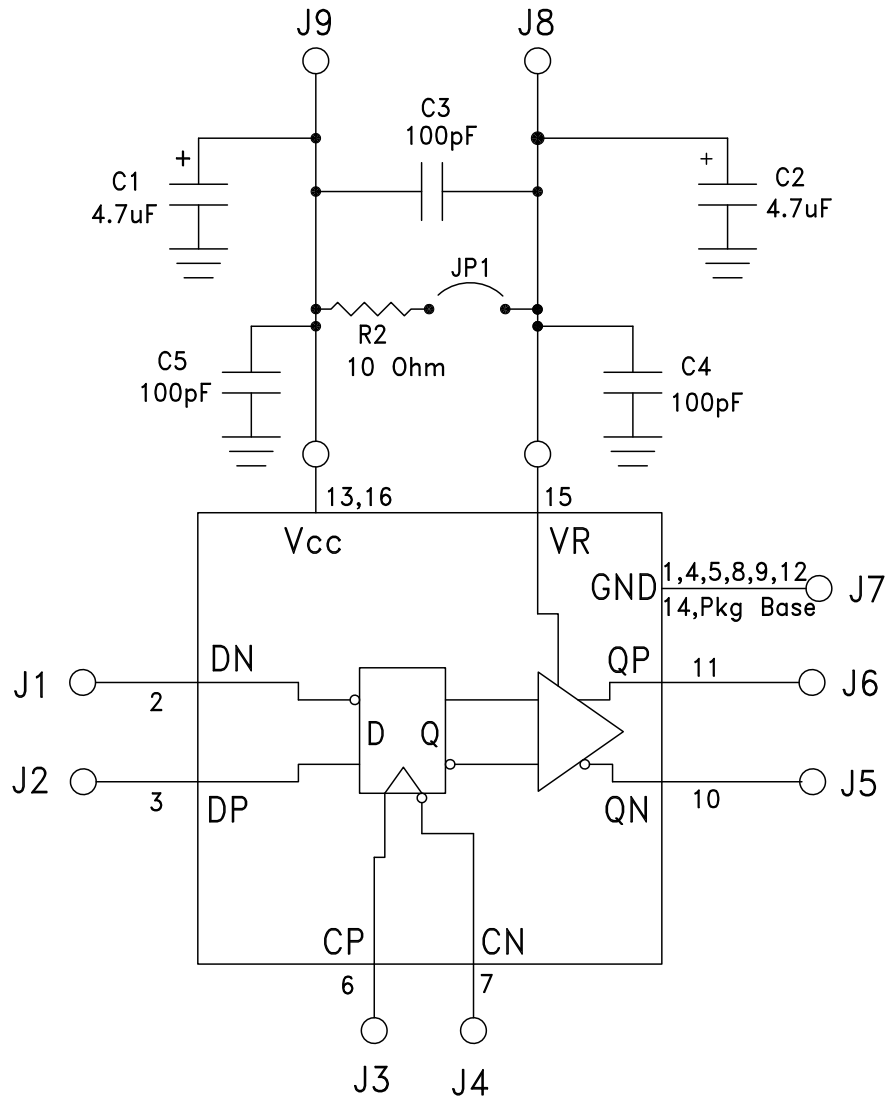
[2] Circuit Board Material: Arlon 25FR or Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. The exposed package base should be connected to GND. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request. Install jumper on JP1 to short VR to Vcc for normal operation.

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Application Circuit





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